2SC5592

Silicon NPN epitaxial planer type

For DC-DC converter
For various driver circuits

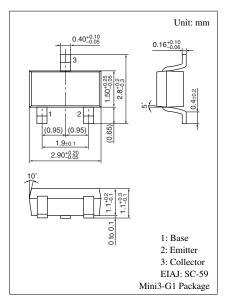
■ Features

- ullet Low collector to emitter saturation voltage $V_{CE(sat)}$
- High-speed switching
- Mini3-G1 type package, allowing downsizing and thinning of the equipment and automatic insertion through the tape packing
- Complementary pair with 2SA2010

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	15	V
Collector to emitter voltage	V _{CEO}	15	V
Emitter to base voltage	V _{EBO}	5	V
Peak collector current	I_{CP}	10	A
Collector current	I_{C}	2.5	A
Collector power dissipation *	$P_{\rm C}$	600	mW
Junction temperature	T _j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Note) *: Measure on the ceramic substrate at $15\times15\times0.6~\text{mm}^3$



Marking Symbol: 2T

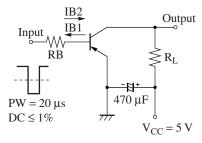
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 10 \text{ V}, I_E = 0$			0.1	μΑ
Collector to base voltage	V_{CBO}	$I_{\rm C} = 10 \; \mu {\rm A}, \; I_{\rm E} = 0$	15			V
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	15			V
Emitter to base voltage	V_{EBO}	$I_{\rm E} = 10 \; \mu \text{A}, \; I_{\rm C} = 0$	5			V
Forward current transfer ratio *1	h _{FE1}	$V_{CE} = 2 \text{ V}, I_{C} = 100 \text{ mA}$	400		1000	
	h _{FE2}	$V_{CE} = 2 \text{ V}, I_{C} = 2.5 \text{ A}$	280			
Collector to emitter saturation voltage *1	V _{CE(sat)}	$I_{\rm C} = 1 \text{ A}, I_{\rm B} = 10 \text{ mA}$		110		mV
		$I_C = 2.5 \text{ A}, I_B = 50 \text{ mA}$		220	320	mV
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		30		pF
Transition frequency	f_T	$V_{CB} = -10 \text{ V}, I_E = -50 \text{ mA}$		180		MHz
		f = 200 MHz				
Turn-on time *2	t _{ON}			30		ns
Storage time *2	t _{stg}			100		ns
Turn-off time *2	t _{off}			10		ns

Note) *1: Pulse measurement

^{*2:} Reference to the measurement circuit

■ Measurement Circuit



-20IB1 = 20IB2 = IC = 1.5 A

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